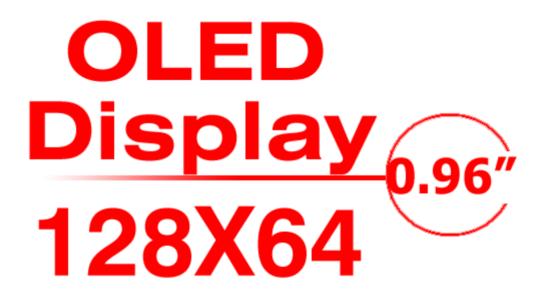
SPECIFICATION

PART NO. : OEL9M0085-G-E



This specification maybe changed without any notice in order to improve performance or quality etc.

Please contact TRULY Semiconductors LTD. OLED R&D department for update specification and product status before design for this product or release the order.

PRODUCT CONTENTS

n PHYSICAL DATA n ABSOLUTE MAXIMUM RATINGS n EXTERNAL DIMENSIONS n ELECTRICAL CHARACTERISTICS n ELECTRO-OPTICAL CHARACTERISTICS n INTERFACE PIN CONNECTIONS n COMMAND TABLE n INITIALIZATION CODE n SCHEMATIC EXAMPLE n RELIABILITY TESTS nOUTGOING QUALITY CONTROL SPECIFICATION n CAUTIONS IN USING OLED MODULE

TRU	LY®信利	Customer	
Written by	ChenYongquan	Арр	roved by
Checked by	YangXueyu		
Approved by	ZhangWeicang		

REVISION HISTORY

Rev.	Contents	Date				
1.0	First release	2014-03-28				

n PHYSICAL DATA

No.	Items:	Specification:	Unit
1	Diagonal Size	0.96	Inch
2	Resolution	128(H) x 64(V)	Dots
3	Active Area	21.740(W) x 11.175(H)	mm ²
4	Outline Dimension (Panel)	26.70(W) x 19.26(H)	mm ²
5	Pixel Pitch	0.170(W) x 0.175(H)	mm ²
6	Pixel Size	0.150(W) x 0.150(H)	mm ²
7	Driver IC	SH1106G	-
8	Display Color	Green	-
9	Grayscale	1	Bit
10	Interface	4-wire Serial	-
11	IC package type	COG	-
12	Thickness	1.45±0.1	mm
13	Weight	TBD	g
14	Duty	1/64	-

n ABSOLUTE MAXIMUM RATINGS

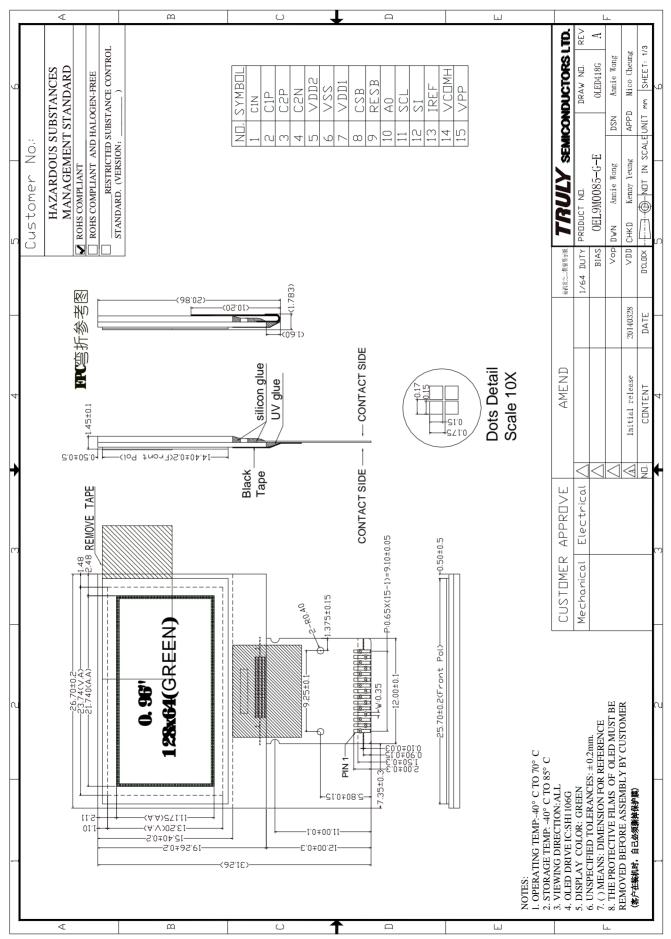
Unless oth	Unless otherwise specified, (Voltage Referenced to V_{SS}) (Ta = 25°C)										
Items		Symbol	Min	Typ.	Max	Unit					
Logic		V _{DD1}	-0.3	-	3.6	V					
Supply Voltage	Logic	V _{DD2}	-0.3		4.3	V V					
, onuge	Driving	V _{PP}	-0.3	-	13.5						
Operating Temperat	<i>,</i>	Тор	-40	-	70	C					
Storage Temperature		Tst	-40 -		85	C					
Humidity		-	-	-	90	%RH					

NOTE:

Permanent device damage may occur if ABSOLUTE MAXIMUM RATINGS are exceeded.

Functional operation should be restricted to the conditions as detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

n EXTERNAL DIMENSIONS



n ELECTRICAL CHARACTERISTICS

•DC Characteristics

Condition(Unless otherwise specified):

Voltage referenced to V_{SS}

V_{DD1}=1.65V to 3.5V

 $Ta = 25^{\circ}C$

Items		Symbol	Min	Тур.	Max	Unit
	Logic	V _{DD1}	1.65	-	3.5	V
Supply Voltage	Charge Pump Regulator Supply Voltage	V _{DD2}	3.0	-	4.2	V
	Operating	$\mathbf{V}_{\mathbf{PP}}$	6.4	-	13.0	V
Input	High Voltage	V _{IH}	0.8 x V _{DD1}	-	V _{DD1}	V
Voltage	Low Voltage	V _{IL}	V _{SS}	-	0.2 x V _{DD1}	V
Output Voltage	High Voltage	V _{OH}	0.8 x V _{DD1}	-	V _{DD1}	V
	Low Voltage	V _{OL}	V _{SS}	-	0.2 x V _{DD1}	V

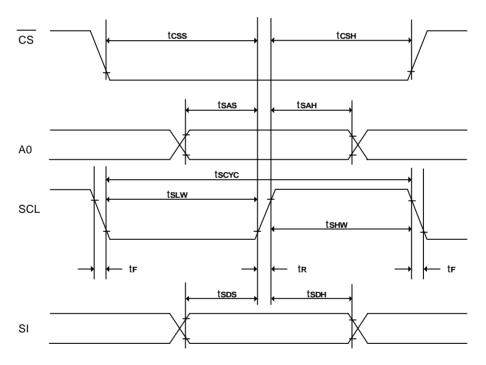
AC Characteristics

1. 4-wire Serial Interface Timing Characteristics

 $(V_{DD1} - V_{SS} = 1.65V \text{ to } 3.3V, T_A = 25^{\circ}C)$

Symbol	Parameter	Min.	Тур.	Max.	Unit	Condition
tscyc	Serial clock cycle	500	-	-	ns	
tsas	Address setup time	300	-	-	ns	
tSAH	Address hold time	300	-	-	ns	
tSDS	Data setup time	200	-	-	ns	
tSDH	Data hold time	200	-	-	ns	
tcss	CS setup time	240 -		-	ns	
tCSH	CS hold time time	120 -		-	ns	
tSHW	Serial clock H pulse width	200	-	-	ns	
tsLw	Serial clock L pulse width	200	-	-	ns	
tR	Rise time	-	-	30	ns	
tF	Fall time	-	-	30	ns	

4-wire Serial Peripheral Interface characteristics



Items		Symbol	Min.	Тур.	Max.	Unit	Remark
Operating Lumi	nance	L	100	120*	-	cd /m ²	VPP Supply Externally
Power Consum	Р	-	20	30	mW	30% pixels ON	
Frame Freque	Fr	-	100	-	Hz	-	
Color Coordinate	Croop	CIE x	0.28	0.31	0.33	CIE1931	Darkroom
Color Coordinate	Green	CIE y	0.59	0.62	0.65	CIEI931	Darkroom
Decrease Time	Rise	Tr	-	-	0.02	ms	-
Response Time	Decay	Td	-	-	0.02	ms	-
Contrast Rat	Cr	10000:1	-	-	-	Darkroom	
Viewing Angle		$\nabla \theta$	160	-	-	Degree	-
Operating Life 7	Тор	30,000	-	-	Hours	L=120cd/m ²	

Note:

1. Driving voltage : VDD1 =3.0V Driving voltage : VPP=9.0V(VPP Supplied Externally). contrast setting :0x14;

2. Contrast ratio is defined as follows:

Contrast ratio = $\frac{Photo - detector output with OLED being$ "white"
Photo - detector output with OLED being"black"

3. Life Time is defined when the Luminance has decayed to less than 50% of the initial Luminance specification. (Odd and even chess board alternately displayed)

(The initial value should be closed to the typical value after adjusting.)

n INTERFACE PIN CONNECTIONS

No	Symbol	Description
1	C1P	
2	C1N	Connect to charge pump capacitor.
3	C2P	These pins are not used and should be disconnedted when Vpp is supplied externally.
4	C2N	
5	VDD2	3.0 – 4.2V power supply pad for Power supply for charge pump circuit.
6	VSS	This is a ground pin
7	VDD1	Power supply input: 1.65 - 3.5V
8	CSB	This is the chip select input.(active LOW)
9	RESB	This is a reset signal input pad. When RES is set to "L", the settings are initialized. The reset operation is performed by the RES signal level.
10	A0	This is the Data/Command control pad that determines whether the data bits are data or a command.
11	SCL	serial clock input pad
12	SI	Serial data input pad
13	IREF	This is a segment current reference pad. A resistor should be connected between this pad and VSS. Set the current at 10µA.
14	VOMH	This is a pad for the voltage output high level for common signals. A capacitor should be connected between this pad and VSS.
15	VPP	Power supply for panel driving voltage. This is also the most positive power voltage supply pin. When charge pump is enabled, a capacitor should be connected between this pin and VSS.

Status	VDD2	VDD1	VPP			
Enable Charge pump	Connect to external VDD2 source	Connect to external	A capacitor should be connected between this pin and GND			
Disable Charge pump	Keep float	VDD1 source	Connect to external VPP source			

n COMMAND TABLE

Command				Function											
Command	A0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0	Function			
1. Set Column Address 4 lower bits	0	1	0	0	0	0	0	Lowe	er colu	dress	Sets 4 lower bits of column address of display RAM in register. (POR = 00H)				
2. Set Column Address 4 higher bits	0	1	0	0	0	0	1	High	er colu	mn ad	dress	Sets 4 higher bits of column address of display RAM in register. (POR = 10H)			
3. Set Pump voltage value	0	1	0	0	0	1	1	0	0 0 Pump voltage value			This command is to control the DC-DC voltage output value. (POR=32H)			
4. Set Display Start Line	0	1	0	0	1			Line a	ddress			Specifies RAM display line for COM0. (POR = 40H)			
5. The Contrast Control Mode Set	0	1	0	1	0	0	0	0	0	0	1	This commandis to set Contrast Settingof the display.			
Contrast Data Register Set	0	1	0		Contrast Data							The chip has 256 contrast steps from 00 to FF. (POR = 80H)			
6. Set Segment Re-map (ADC)	0	1	0	1	0	1	0	0	0	0	ADC	The right (0) or left (1) rotation. (POR = A0H)			
7. Set Entire Display OFF/ON	0	1	0	1	0	1	0	0	1	0	D	Selects normal display (0) or Entire Display ON (1). (POR = A4H)			
8. Set Normal/ Reverse Display	0	1	0	1	0	1	0	0	1	1	D	Normal indication (0) when low, but reverse indication (1) when high. (POR = A6H)			
9 Multiplex Ration Mode Set	0	1	0	1	0	1	0	1	0	0	0	This command switches default 63 multiplex mode to			
Multiplex Ration Data Set	0	1	0	*	*		Ν	Aultiple	ex Rati	0		any multiplex ratio from 1 to 64. (POR = 3FH)			
10. DC-DC Control Mode Set	0	1	0	1	0	1	0	1	1	0	1	This command is to control the DC-DC voltage DC-DC			
DC-DC ON/OFF Mode Set	0	1	0	1	0	0	0	1	0	1	D	will be turned on when display on converter (1) or DC-DC OFF (0). (POR = 8BH)			

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Rev : 1.0 Mar.28, 2014

Code									Function				
Command	A0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0	Function	
11. Display OFF/ON	0	1	0	1	0	1	0	1	1	1	D	Turns on OLED panel (1) or turns off (0). (POR = AEH)	
12. Set Page Address	0	1	0	1	0	1	1		Page Address		6	Specifies page address to load display RAM data to page address register. (POR = B0H)	
13. Set Common Output Scan Direction	0	1	0	1	1	0	0	D	*	*	*	Scan from COM0 to COM [N - 1] (0) or Scan from COM [N -1] to COM0 (1). (POR = C0H)	
14. Display Offset Mode Set	0	1	0	1	1	0	1	0	0	1	1	This is a double byte command which specifies	
Display Offset Data Set	0	1	0	*	*			СС	ЭМх			the mapping of display start line to one of COM0-63. (POR = 00H)	
15. Set Display Divide Ratio/Oscilator Frequency Mode Set	0	1	0	1	1	0	1	0	1	0	1	This command is used to set the frequency of the internal display clocks. (POR = 50H)	
Divide Ratio/Osdilator Frequency Data Set	0	1	0	Osc	illator	Freque	ency		Divide	e Ratio			
16. Dis-charge / Pre-charge Period Mode Set	0	1	0	1	1	0	1	1	0	0	1	This command is used to set the duration of the dis-charge and pre-charge	
Dis-charge /Pre-charge Period Data Set	0	1	0	Dis	s-char	ge Peri	iod	Pr	e-char	ge Peri	iod	period. (POR = 22H)	
17. Common Pads Hardware Configuration Mode Set	0	1	0	1	1	0	1	1	0	1	0	This command is to set the common signals pad configuration. (POR = 12H)	
Sequential/Alternat ive Mode Set	0	1	0	0	0	0	D	0	0	1	0		
18. VCOM Deselect Level Mode Set	0	1	0	1	1	0	1	1	0	1	1	This command is to set the common pad output voltage	
VCOM Deselect Level Data Set	0	1	0			VC	COM (3 X Vref)				level at deselect stage. (POR = 35H)	
19. Read-Modify-Write	0	1	0	1	1	1	0	0	0	0	0	Read-Modify-Write start.	
20. End	0	1	0	1	1	1	0	1	1	1	0	Read-Modify-Write end.	
21. NOP	0	1	0	1	1	1	0	0	0	1	1	Non-Operation Command	
22. Write Display Data	1	1	0		Write RAM data								
23. Read Status	0	0	1	BUSY	ON/ OFF	*	*	*	0	0	0		
24. Read Display Data	1	0	1			R	ead R	AM da	ta				

Note: *Do not use any other commands, or the system malfunction may result.

*When the display OFF command(AEH) is executed, power saver mode(Sleep mode) will be entered. This mode stops every operation of the OLED display system, and can reduce current consumption nearly to a static current value if no access is made from the microprocessor. The internal status in the sleep mode is as follows:

1) Stops the oscillator circuit and DC-DC circuit.

2) Stops the OLED drive and outputs Hz as the segment/common driver output.

3) Holds the display data and operation mode provided before the start of the sleep mode.

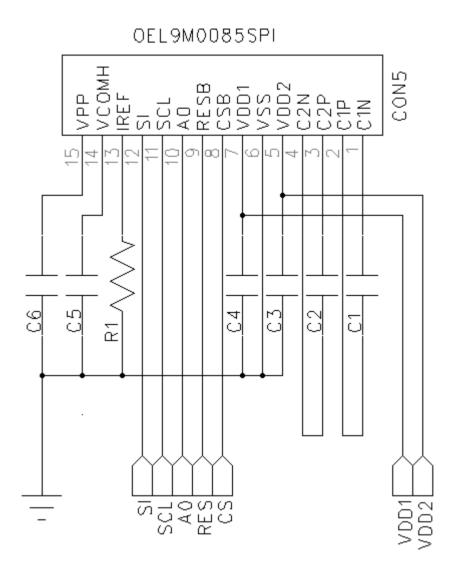
4) The MPU can access to the built-in display RAM.

n INITIALIZATION CODE void InitOLED_MASTER_SH1106G(void) {

MainOLED_WCom(0xAE);	//DOT MARTIX DISPLAY OFF		
MainOLED_WCom(0x33);	//SET PUMP VOLTAGE		
MainOLED_WCom(0x40);	//SET DISPLAY START LINE(40H-7FH)		
MainOLED_WCom(0x81); MainOLED_WCom(CONTARS)	//CONTARST CONTROL(00H-0FFH) F);		
MainOLED_WCom(0xA1); MainOLED_WCom(0xA4); MainOLED_WCom(0xA6);	//SET SEGMENT RE-MAP(0A0H-0A1H) //ENTIRE DISPLAY OFF(0A4H-0A5H) //SET NORMAL DISPLAY(0A6H-0A7H)		
MainOLED_WCom(0xA8); MainOLED_WCom(0x3F);	//SET MULTIPLEX RATIO 64		
MainOLED_WCom(0xAD); MainOLED_WCom(0x8A);	//SET DC/D BOOSTER(8AH=OFF,8BH=ON)		
MainOLED_WCom(0xC8);	//COM SCAN COM1-COM64(0C8H,0C0H)		
MainOLED_WCom(0xD3); MainOLED_WCom(0x00);	//SET DISPLAY OFFSET(OOH-3FH)		
MainOLED_WCom(0xD5); MainOLED_WCom(0x90);	//SET FRAME FREQUENCY		
MainOLED_WCom(0xD9); MainOLED_WCom(0x1F);	//SET PRE_CHARGE PERIOD		
MainOLED_WCom(0xDA); MainOLED_WCom(0x12);	//COM PIN CONFIGURATION(02H,12H)		
MainOLED_WCom(0xDB); MainOLED_WCom(0x40);	//SET VCOM DESELECT LEVEL(35H)		
Delayms(100); MainOLED_WCom(0xAF); }	//DSPLAY ON		

n SCHEMATIC EXAMPLE

♦Serial Interface Application Circuit(Internal Charge Pump):



NOTE:

- 1. R1= (Voltage at IREF VSS)/IREF≈510KΩ,C1=C2=0.22uF, C3=C4=C5=C6=4.7uF;
- 2. The V_{DD1} V_{DD2} should connect a external voltage;
- 3. In Serial interface mode ,the read function is not possible.

n RELIABILITY TESTS

	Item	Condition	Criterion		
High Temperature Storage (HTS)		85±2℃, 200 hours	 After testing, the function test is ok. After testing, no addition to the defect. 		
High Temperature Operating (HTO)		70±2℃, 96 hours	3. After testing, the change of luminance should be within +/- 50% of initial value.		
Low Temperature Storage (LTS)		-40±2°C , 200 hours	4. After testing, the change for the mono and area color must be within (+/-0.02, +/-		
Low Temperature Operating (LTO)		-40±2°C, 96 hours	0.02) and for the full color it must be within (+/-0.04, +/-0.04) of initial value based on		
High Temperature / High Humidity Storage (HTHHS)		50±3℃, 90%±3%RH, 120 hours	1931 CIE coordinates.5. After testing, the change of total current consumption		
Thermal Shock (Non-operation) (TS)		-40±2°C ~ 25°C ~ 70±2°C (30min) (5min) (30min) 10cycles	should be within +/- 50% of initial value.		
Vibration (Packing) Drop (Packing)	10~55~10Hz,amplitu de 1.5mm, 1 hour for each direction x, y, z Height : 1 m, each time for 6 sides, 3	 One box for each test. No addition to the cosmet defects. 	ic and the electrical		
ESD (finished product housing)	edges, 1 angle ±4kV (R: 330Ω C: 150pF , 10times, air discharge)	 After testing, cosmetic and electrical defects should not happen. In case of malfunction or defect caused by ESD damage, it would be judged as a good part if it would be recovered to normal state after resetting. 			

Note: 1) For each reliability test, the sample quantity is 3, and only for one test item.

2) The HTHHS test is requested the Pure Water(Resistance>10M Ω).

3) The test should be done after 2 hours of recovery time in normal environment.

n OUTGOING QUALITY CONTROL SPECIFICATION

◆Standard

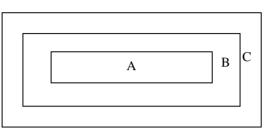
According to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993, General Inspection Level II.

Definition

1 Major defect : The defect that greatly affect the usability of product.

2 Minor defect : The other defects, such as cosmetic defects, etc.

3 Definition of inspection zone:



Zone A: Active Area

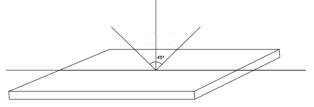
Zone B: Viewing Area except Zone A

Zone C: Outside Viewing Area

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble of quality and assembly to customer's product.

♦ Inspection Methods

1 The general inspection : under 20W x 2 or 40W fluorescent light, about 30cm viewing distance, within 45° viewing angle, under 25±5℃.



2 The luminance and color coordinate inspection : By PR705 or BM-7 or the equal equipments, in the dark room, under 25 ± 5 °C.

♦Inspection Criteria

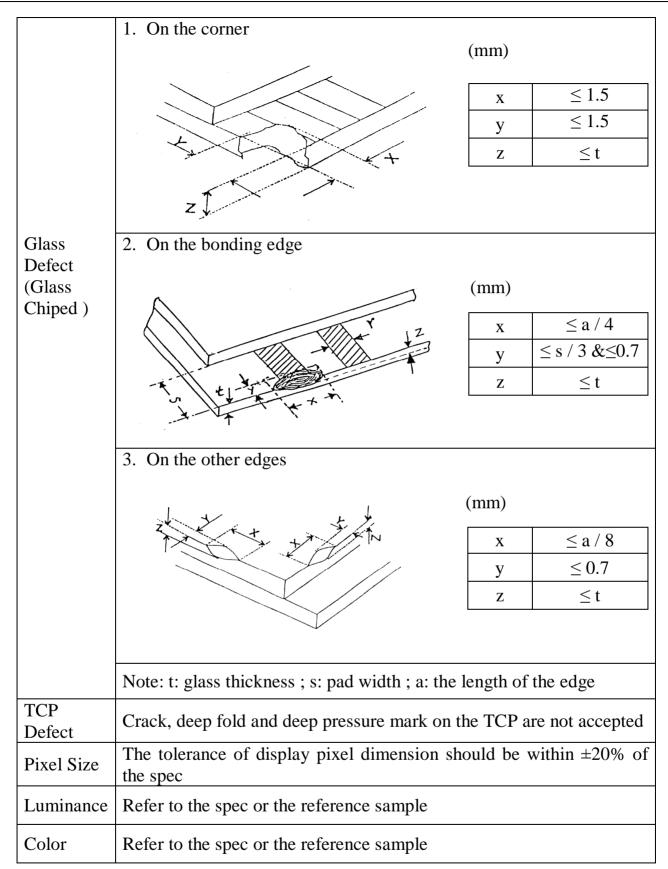
1 Major defect : AQL= 0.65

Joi delett : MQL= 0.05				
Item	Criterion			
	1. No display or abnormal display is not accepted			
Function Defect	2. Open or short is not accepted.			
	3. Power consumption exceeding the spec is not accepted.			
Outline Dimension	Outline dimension exceeding the spec is not accepted.			
Glass Crack	Glass crack tends to enlarge is not accepted.			
Ainor Defect : AOI = 1.5				

2 Minor Defect : AQL= 1.5

Item	Criterion					
Spot Defect (dimming and lighting spot)	Size (mm)		Accepted Qty			
			Area A + Area B	Area C		
		$\Phi \leq 0.07$	Ignored	I		
	X Y	$0.07 < \Phi \le 0.10$	3	Ignored		
		0.10<Φ≦0.15	1			
		0.15<Φ	0			
	Note : $\Phi = (x + y) / 2$					
Line Defect (dimming and	L (Length):mm	W (Width):mm	Area A + Area B	Area C		
	/	W≦0.02	Ignored	<u> </u>		
	L≦3.0	$0.02 \le W \le 0.03$	2			
lighting	L≦2.0	$0.03 \le W \le 0.05$	1	Ignored		
line)	/	0.05 <w< td=""><td>As spot defect</td><td></td></w<>	As spot defect			
Remarks: The total of spot defect and line defect shall not exceed 4 pcs. The distance between two lines defects must exceed 1 mmPolarizerStain which can be wiped off lightly with a soft cloth or similar						
Stain	cleaning is accepted, otherwise, according to the Spot Defect and the Line Defect.					
	 If scratch can be seen during operation, according to the criterions of the Spot Defect and the Line Defect. 					
	2. If scratch can be seen only under non-operation or some special angle, the criterion is as below :					
Polarizer Scratch	L (Length): mm	W (Width):mm	Area A + Area B	Area C		
	/	W≦0.02	Ignore			
	3.0 <l≦5.0< td=""><td>$0.02 \le W \le 0.04$</td><td>2</td><td></td></l≦5.0<>	$0.02 \le W \le 0.04$	2			
	L≦3.0	$0.04 \le W \le 0.06$	1	Ignore		
	/	0.06 <w< td=""><td>0</td><td></td></w<>	0			
Polarizer Air Bubble	Size		Area A + Area B	Area C		
		Φ≦0.20	Ignored			
	Y	$0.20 < \Phi \le 0.30$	2			
	X	$0.30 < \Phi \le 0.50$	1	Ignored		
		$0.50 {<} \Phi$	0			

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n CAUTIONS IN USING OLED MODULE

Precautions For Handling OLED Module:

1. OLED module consists of glass and polarizer. Pay attention to the following items when handling:

- i. Avoid drop from high, avoid excessive impact and pressure.
- ii. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead.
- iii. If the surface becomes dirty, breathe on the surface and gently wipe it off with a soft dry cloth. If it is terrible dirty, moisten the soft cloth with Isopropyl alcohol or Ethyl alcohol. Other solvents may damage the polarizer. Especially water, Ketone and Aromatic solvents.
- iv. Wipe off saliva or water drops immediately, contact the polarizer with water over a long period of time may cause deformation.
- v. Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peeling-off may occur with high temperature and high humidity.
- vi. Condensation on the surface and the terminals due to cold or anything will damage, stain or dirty the polarizer, so make it clean as the way of iii.
- 2. Do not attempt to disassemble or process the OLED Module.
- 3. Make sure the TCP or the FPC of the Module is free of twisting, warping and distortion, do not pull or bend them forcefully, especially the soldering pins. On the other side, the SLIT part of the TCP is made to bend in the necessary case.
- 4. When assembling the module into other equipment, give the glass enough space to avoid excessive pressure on the glass, especially the glass cover which is much more fragile.
- 5. Be sure to keep the air pressure under 120 kPa, otherwise the glass cover is to be cracked.
- 6. Be careful to prevent damage by static electricity:
 - i. Be sure to ground the body when handling the OLED Modules.
 - ii. All machines and tools required for assembling, such as soldering irons, must be properly grounded.
 - iii. Do not assemble and do no other work under dry conditions to reduce the amount of static electricity generated. A relative humidity of 50%-60% is recommended.

iv. Peel off the protective film slowly to avoid the amount of static electricity generated.

v. Avoid to touch the circuit, the soldering pins and the IC on the Module by the body.

vi. Be sure to use anti-static package.

- 7. Contamination on terminals can cause an electrochemical reaction and corrade the terminal circuit, so make it clean anytime.
- 8. All terminals should be open, do not attach any conductor or semiconductor on the terminals.
- 9. When the logic circuit power is off, do not apply the input signals.
- 10. Power on sequence: $V_{DD1} \rightarrow V_{PP}$, and power off sequence: $V_{PP} \rightarrow V_{DD1}$.
- 11. Be sure to keep temperature, humidity and voltage within the ranges of the spec, otherwise shorten Module' s life time, even make it damaged.
- 12. Be sure to drive the OLED Module following the Specification and datasheet of IC controller, otherwise something wrong may be seen.

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13. When displaying images, keep them rolling, and avoid one fixed image displaying more than 30 seconds, otherwise the residue image is to be seen. This is the speciality of OLED.

Precautions For Soldering OLED Module:

- 1. Soldering temperature : $260^{\circ}C \pm 10^{\circ}C$.
- 2. Soldering time : 3-4 sec.
- 3. Repeating time : no more than 3 times.
- 4. If soldering flux is used, be sure to remove any remaining flux after finishing soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended to protect the surface with a cover during soldering to prevent any damage due to flux spatters.

Precautions For Storing OLED Module:

- 1. Be sure to store the OLED Module in the vacuum bag with dessicant.
- 2. If the Module can not be used up in 1 month after the bag being opened, make sure to seal the Module in the vacuum bag with dessicant again.
- 3. Store the Module in a dark place, do not expose to sunlight or fluorescent light.
- 4. The polarizer surface should not touch any other objects. It is recommended to store the Module in the shipping container.
- 5. It is recommended to keep the temperature between $0^{\circ}C$ and $30^{\circ}C$, the relative humidity not over 60%.

◆ Limited Warranty

Unless relevant quality agreements signed with customer and law enforcement, for a period of 12 months from date of production, all products (except automotive products) TRULY will replace or repair any of its OLED modules which are found to be functional defect when inspected in accordance with TRULY OLED acceptance standards (copies available upon request). Cosmetic/visual defects must be returned to TRULY within 90 days of shipment. Confirmation of such date should be based on freight documents. The warranty liability of TRULY is limited to repair and/or replacement on the terms above. TRULY will not be responsible for any subsequent or consequential events.

♦ Return OLED Module Under Warranty:

- 1. No warranty in the case that the precautions are disregarded.
- 2. Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects.

♦ PRIOR CONSULT MATTER

- 1. For TRULY standard products, we keep the right to change material, process ... for improving the product property without any notice on our customer.
- 2. If you have special requirement about reliability condition, please let us know before you start the test on our samples.